

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	2ED21064S06J	**Issued**	08. April 2021
MA#	MA005339346		
Package	PG-DSO-14-70	**Weight***	138.35 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.437	1.04	1.04	10383	10383
leadframe	inorganic material	phosphorus	7723-14-0	0.014	0.01		104	
	non noble metal	zinc	7440-66-6	0.057	0.04		415	
	non noble metal	iron	7439-89-6	1.150	0.83		8309	
	non noble metal	copper	7440-50-8	46.675	33.74	34.62	337363	346191
wires	noble metal	palladium	7440-05-3	0.000			3	
	non noble metal	copper	7440-50-8	0.047	0.03	0.03	341	344
encapsulation	organic material	carbon black	1333-86-4	0.347	0.25		2509	
	plastics	epoxy resin	-	12.581	9.09		90934	
	inorganic material	silicondioxide	60676-86-0	73.836	53.37	62.71	533683	627126
leadfinish	non noble metal	tin	7440-31-5	1.226	0.89	0.89	8863	8863
plating	noble metal	silver	7440-22-4	0.307	0.22	0.22	2215	2215
glue	plastics	acrylic resin	-	0.148	0.11		1073	
	noble metal	silver	7440-22-4	0.526	0.38	0.49	3805	4878
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

Company	Infineon Technologies AG
Address	81726 Neubiberg
Internet	www.infineon.com